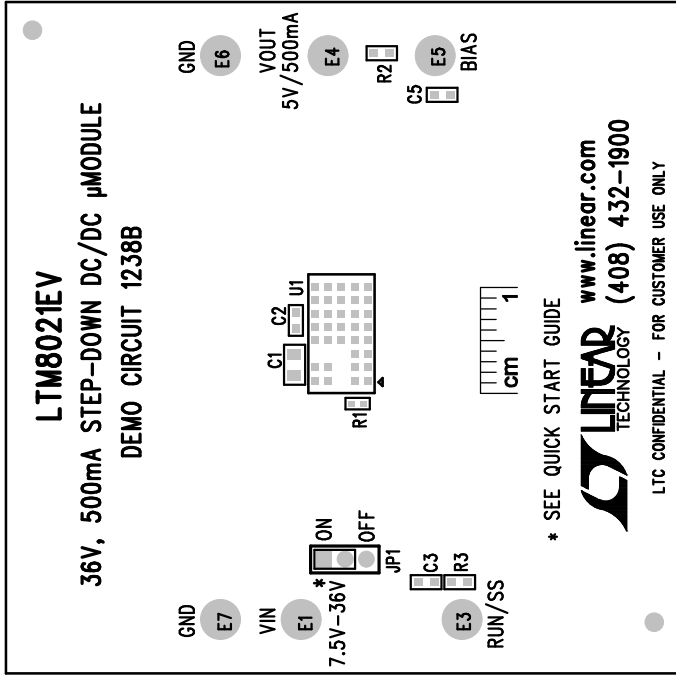



REVISION HISTORY			
ECO	REV	DESCRIPTION	APP. ENG.
1	1	PRODUCTION	MOLLY Z.
			DATE
			4-9-12

NOTES: UNLESS OTHERWISE SPECIFIED

1. WORKMANSHIP SHALL BE IN ACCORDANCE WITH IPC-A-610.
2. ASSEMBLY PROCESS SHALL INCLUDE: REFLOW SOLDER TOP SIDE SMD. MAXIMUM SOLDER TEMPERATURE IS 240 DEGREES CELSIUS.
3. PARTS TO OMIT WILL BE SPECIFIED ON THE BILL OF MATERIALS. LOCATIONS OF OMITTED PARTS SHALL BE FREE OF SOLDER. MASK THE SOLDER STENCIL WHERE SMT PARTS ARE OMITTED.
4. INSTALL SHUNTS AS SHOWN ON ASSY DRAWING.
5. DEPANELIZE BOARDS AFTER ASSEMBLY AND ROUTE-OUT THE BREAKOUT TABS ON FOUR SIDES OF THE BOARD EDGE.
6. DO NOT APPLY ANY KIND OF ASSEMBLY STAMP OR QA STAMP TO ANY BOARD.



APPROVALS				1630 MCCARTHY BLVD MILPITAS, CA 95035 PH: (408)432-1900 www.linear.com LTC CONFIDENTIAL- FOR CUSTOMER USE ONLY	
PCB DES.	HZ				
APP ENG.	MOLLY Z.	TITLE: TOP ASSEMBLY DRAWING		36V, 500mA STEP-DOWN DC/DC μ MODULE	
		SIZE IC NO. LTM8021EV		REV. 1	
		N/A DEMO CIRCUIT 1238B		FILENAME: DC1238B-1.PCB	
SCALE = NONE		SHT 1 OF 1			